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Communication

Concurrent improvement in optical and electrical characteristics by using inverted pyramidal array structures toward efficient Si ¹⁷₁₅ ¹⁷₂₂ heterojunction solar cells

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ABSTRACT

The Si heterojunction (SH]) solar cell is presently the most popular design in the crystalline Si (c-Si) photovoltaics due to the high open-circuit voltages (V_{OC}). Photon management by surface structuring techniques to control the light entering the devices is critical for boosting cell efficiency although it usually comes with the V_{OC} loss caused by severe surface recombination. For the first time, the periodic inverted pyramid (IP) structure fabricated by photolithography and anisotropic etching processes was employed for SHJ solar cells, demonstrating concurrent improvement in optical and electrical characteristics (i.e., short-circuit current density (J_{SC}) and V_{OC}). Periodic IP structures show superior lightharvesting properties as most of the incident rays bounce three times on the walls of the IPs but only twice between conventional random upright pyramids (UPs). The high minority carrier lifetime of the IP structures after a-Si:H passivation results in an enhanced $V_{\rm OC}$ by 28 mV, showing improved carrier collection efficiency due to the superior passivation of the IP structure over the random UP structures. The superior antireflective (AR) ability and passivation results demonstrate that the IP structure has the potential to replace conventional UP structures to further boost the efficiency in solar cell applications. © 2016 Elsevier Ltd. All rights reserved.

1. Introduction

Energy harvesting in photovoltaic (PV) devices has become critical with continuous improvements in cell design for boosting cell efficiency. A lot of research efforts have focused on photon management to precisely control the light at the active layer to efficiently generate photocarriers. However, most of light-trapping schemes by employing surface structuring techniques usually accompany electrical losses (e.g., carrier recombination by surface states or contact losses) [1–3]. The expected boosted short-circuit current density (J_{SC}) would be partially compromised by poor open-circuit voltages (V_{OC}) and fill factors (FF). Therefore, no matter what light-trapping techniques are applied on PV devices, the electrical properties need to be considered. How to optimize the trade-off between optical gain and electrical loss or even concurrently improve both optical and electrical characteristics become the most important issues for putting photon management into practice.

Heterojunction structure has been widely studied for different types of solar cells [4–7]. Generally, great solar cells must generate maximum photocarriers by broadband absorption at active region,

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but also assure these photo-generated carriers can be efficiently collected with minimal recombination when they travel to the terminals of the device. High recombination increases the diode saturation current, reducing the V_{OC} . By insertion of a film with wide bandgap, the carrier recombination can be efficiently reduced due to a large band offset at the heterojunction interface, leading to a higher V_{OC} [8]. Recently, the amorphous/crystalline Si (a-Si/c-Si) heterojunction solar cell structure currently is the most popular design in c-Si PV industries. It combines the advantages of c-Si solar cells with the excellent absorption and long minority carrier lifetimes and the advantage of hydrogenated a-Si (a-Si:H) with passivation characteristics [9]. The most impressive feature of this structure is its high V_{OC} which occurs due to the significant passivation effect of *a*-Si:H. Not only can the surface state density of *c*-Si be reduced, but the wide bandgap of *a*-Si:H generates a large band offset at the *a*-Si:H/*c*-Si interface, minimizing the carrier recombination loss [10]. In 2014, a world-record high efficiency among all kinds of Si-based solar cells of 25.6% was obtained with a Si heterojunction (SHJ) combined with an interdigitated back contact design [11]. According to loss analysis, the optical loss was 60–70% of the total loss [12]. By using an interdigitated back contact design, the optical loss from the metal grid electrodes and absorption of ITO on the front side can be avoided, leading to an improvement in the J_{SC} of 2.3 mA/cm².

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1 *J*_{SC} enhancement *via* light-trapping structures is another choice 2 to further improve the performance of SHJ solar cells. However, it 3 is critical to design antireflective (AR) structures for SHJ solar cells. 4 In addition to exceptional AR ability, to avoid sacrificing the high 5 $V_{\rm OC}$, it is important to well passivate the surface of solar cells. In 6 the SHJ case, cells must be able to be well passivated by intrinsic a-7 Si:H films as thin as 5 nm. But it is difficult to employ high aspect-8 ratio light-trapping structures such as nanowires in SHJ solar cells 9 because of the non-uniform coverage of a-Si:H and subsequent 10 layers, which results in the degradation of the PV performance 11 [13–18]. A random upright pyramid (UP) structure fabricated by 12 anisotropic wet chemical etching is the most commonly used for 13 c-Si-based solar cells [19–22]. However, the various sizes of ran-14 dom UPs with sharp pyramidal peaks do not appear to be good 15 enough for a-Si:H passivation. A chemical polish treatment for 16 structured surfaces has been developed to improve the passivation 17 effect, but there is a corresponding decrease in the light-trapping 18 ability [14,18,23,24]. Inverted pyramid (IP) structures, which show 19 better light confinement than UP structures, might be a good 20 candidate for SHJ solar cells [25-28]. Moreover, since the 21 morphologies of IP structures are relatively uniform, without 22 sharp peaks, they have the potential to offer better passivation 23 results, resulting in higher V_{OC} .

24 Many researches only discussed the AR properties of IP struc-25 tures, neglecting to look into the electrical properties after ap-26 plying on practical devices. A comparison of IP structures with 27 conventional random UP structures in SHJ devices has not yet been 28 made. Thus, in this work, SHJ solar cells with polished, random UP 29 and different sizes of IP surfaces are compared. The influences on 30 the AR ability and the passivation effect of different geometric 31 structures are investigated. It is found that the average total reflectance (R_{total}) of SHJ cells can be suppressed to less than 4.5% 32 33 over a wide spectral range from 400 to 1000 nm by using the IP with 10 μ m periodicity. There is a big enhancement in the J_{SC} and 34 35 power conversion efficiency (CE) for IP textured SHJ solar cells 36 (35.3 mA/cm² and 14.6%) compared to the random UP textured SHJ 37 solar cells (34.2 mA/cm² and 12.7%). It is noteworthy that the V_{OC} 38 of the IP textured SHJ solar cells is 28 mV higher than that of the 39 random UPs, indicating the superior passivation of the IP structure 40 over the random UP textured structures. We demonstrate that the 41 IP structures with their superior AR ability and passivation results 42 have the potential to replace the random UP structures, to further 43 boost the efficiency in SHJ solar cell applications. Finally, the SHJ solar cell with the optimized IP structure exhibits a CE of 14.6% 44 with J_{SC} of 35.3 mA/cm², V_{OC} of 605.4 mV, and FF of 68.4%. 45

2. Experimental section

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The SHJ solar cells were fabricated using the process illustrated in the flowchart in Fig. S1 in Supporting Information. Random UPs and periodic IPs were fabricated on 4-in. n-type monocrystalline Si Czochralski (001) wafers with a thickness of 200 μ m. The random UP structures were obtained by immersing the Si substrates in a potassium hydroxide solution (KOH:IPA:H₂O=1:1:17) for 20 min at 85 °C. Rectangular arrays with different periodicities were patterned by photolithography using the IP fabrication process. After this, a 30-nm-thick SiO₂ layer was deposited as an etching mask. After the lift-off process, the substrates with patterned SiO₂ layers were immersed in a potassium hydroxide solution (KOH:IPA:H₂O =1:1:17) at 85 °C. After SiO₂ removal by HF, IP structures with different periodicities were obtained. Subsequently, all patterned substrates were cleaned by the standard RCA process followed by dipping in 1% HF. To fabricate SHJ solar cells, an intrinsic buffer (10 nm)/p-type-doped a-Si:H layer (6 nm) were deposited on the front, and an intrinsic buffer (10 nm)/n-type-doped a-Si:H layer

(10 nm) were deposited on the back by plasma-enhanced chemical vapor deposition (PECVD) at 150 °C. A 92-nm-thick ITO layer was deposited by sputtering on the both sides as a transparent conducting layer. After deposition of the ITO films, the cells were annealed at 210 °C in air for 30 min. Finally, Ag grids were deposited on the both sides by e-beam evaporation.

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Morphological studies were carried out using JEOL JSM-6500 field emission SEM. Reflectance measurements were performed by a JASCO V-670 UV–vis spectrometer equipped with an integral sphere. The minority carrier lifetime measurement was analyzed using the quasi-steady-state photoconductance technique (QSSPC) on a Sinton WCT120. The PV performance of the current density-voltage (J–V) characteristics was monitored under illumination by an air mass (AM) 1.5G solar simulator at 100 mW/cm² with a Keithley 2400 source meter. External quantum efficiency (EQE) measurements were performed by coupling a Halogen lamp to a monochromator.

3. Results and discussion

Fig. 1a shows the structure of a complete SHJ solar cell. Fig. 1b-87 88 d illustrates three kinds of Si surfaces for comparison: polished, 89 random UP, and periodic IP surfaces. The SEM images of the random UP and the periodic IP structures are shown in Fig. 1e and f. 90 Conventional random UPs ranging from 7 to 14 µm in width were 91 92 fabricated by immersing as-cut Si substrates in an anisotropic etching solution. Some pyramids less than 1 µm in width or half 93 pyramids were also generated between big pyramids (Fig. 1e). It is 94 difficult to obtain a surface with the same size of UPs by only using 95 wet etching, even changing concentration of etching solution, 96 time, or temperature [29]. Pyramids with an angle of 54.7° to the 97 wafer surface formed at a much higher etching rate in the [100] 98 direction than that in the [111] direction due to the higher atomic 99 density in the (111) plane than that in the (100) plane [30]. Large 100 areas of periodic IP structures with different periodicities were 101 obtained by using photolithography technique combined with the 102 anisotropic etching process. Fig. S2a-S2c in Supporting Informa-103 tion show the SEM images of the IP structures with periodicities of 104 6, 10, and 14 μ m, respectively. The sizes of the IPs are controlled by 105 photolithography and etching time. The ridge width of the IP 106 structures is controlled in the range of $1-1.5 \,\mu\text{m}$. 107

To investigate the light-harvesting abilities of the IP structures, 108 the spectral R_{total} was measured for comparison with substrates 109 with polished and random UP surfaces. Fig. S3 in Supporting In-110 formation shows the R_{total} of IP structures with different periodi-111 cities to first optimize the IP structures. The IP structure with a 10-112 μm periodicity exhibits the lowest reflectance over the wavelength 113 range from 300 to 1100 nm. Optical and electrical properties of IP 114 with optimized 10-µm periodicity would be compared with po-115 lished and random UP surfaces in the following study. In contrast 116 to polished and UP surfaces, the IP surface reduces the reflectance 117 over the broadband regions and exhibits reduced average R_{total} 118 from 41.2% (polished surface) and 19.2% (random UP surface) to 119 120 15.3% (Fig. 2a). The IP surface shows lower R_{total} than the random UP surface because of the superior light-trapping ability of the 121 periodic IP structures. The incident rays bounce multiple times off 122 the pyramidal structures with incident light absorbed during every 123 bounce. The large difference in the size of the UPs is dis-124 advantageous to confining the light within the structures. More-125 over, from the simulation, it can be seen that most of the incident 126 rays bounce three times on the walls of the IPs but only twice 127 between the UPs. The increased number of bounces of reflected 128 light in the IPs increases the probability of light absorption 129 130 [26,27,31]. Furthermore, the light scattered by the structures en-131 ters the substrates at oblique angles, increasing the length of the 132 optical path, which is important especially in solar cell application.

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